DIMENSIONING AND TOLERANCING PER

PAD AS WELL AS THE TERMINALS.

0.10

ASME Y14.5M, 1994 . CONTROLLING DIMENSION: MILLIMETERS. DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP. COPLANARITY APPLIES TO THE EXPOSED

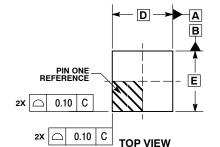




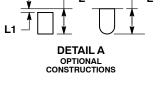
NOTE 4

## DFN8 2x2, 0.5P CASE 506AA **ISSUE F**

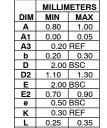
**DATE 04 MAY 2016** 



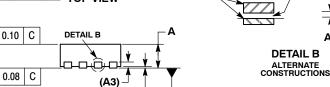




MOLD CMPD



NOTES

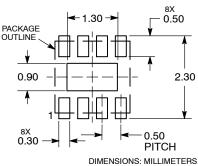


**EXPOSED Cu** 

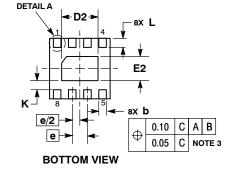
SEATING PLANE

C

## **RECOMMENDED**



SOLDERING FOOTPRINT\*



## \*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## **GENERIC MARKING DIAGRAM\***

SIDE VIEW



XX = Specific Device Code

= Date Code

= Pb-Free Device

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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|------------------|----------------------------|---|-------------|
| DESCRIPTION:     | DFN8, 2.0X2.0, 0.5MM PITCH |   | PAGE 1 OF 1 |

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